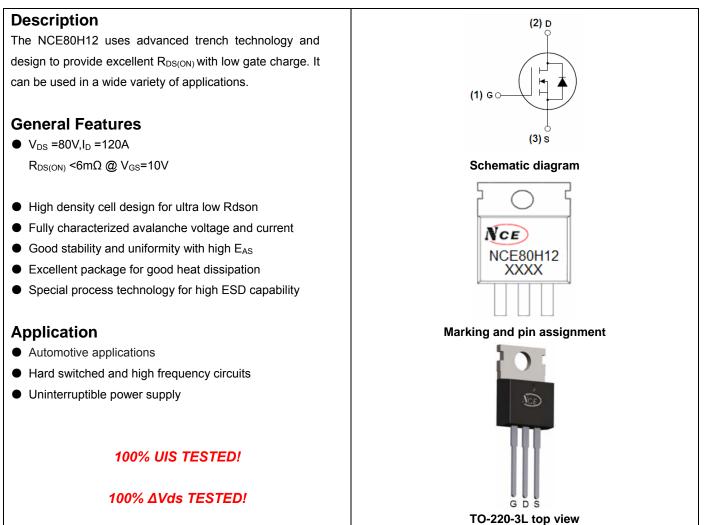


NCE80H12

NCE N-Channel Enhancement Mode Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE80H12	NCE80H12	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	80	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	120	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	84	А
Pulsed Drain Current	I _{DM}	450	А
Maximum Power Dissipation	PD	220	W
Derating factor		1.47	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1400	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ extsf{ heta}JC}$	0.68	°C/W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	80	89	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	4.9	6	mΩ
Forward Transconductance	g fs	V _{DS} =25V,I _D =5A	90	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	6500	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	520	-	PF
Reverse Transfer Capacitance	C _{rss}		-	460	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	26	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A	-	24	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	91	-	nS
Turn-Off Fall Time	t _f		-	39	-	nS
Total Gate Charge	Qg	V -20V(L -20A	-	163		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=30A,$	-	31		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	64		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	120	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	42	60	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	66	80	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				y LS+LD)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \!\! \mathbb{C}$,V_{DD}=40V,V_G=10V,L=0.5mH,Rg=25\Omega



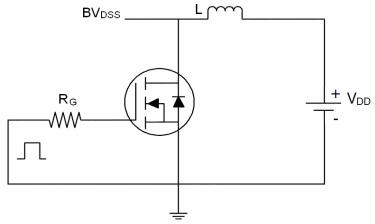
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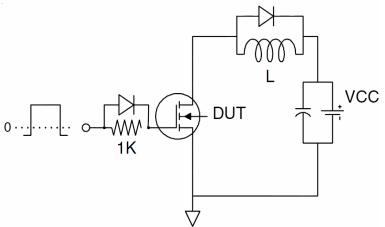


Test circuit

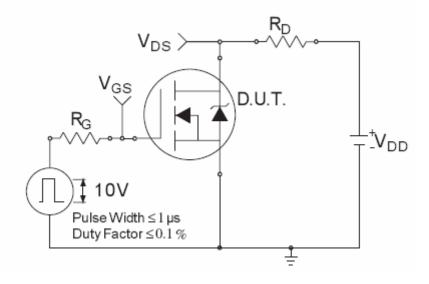
1) E_{AS} test Circuit



2) Gate charge test Circuit

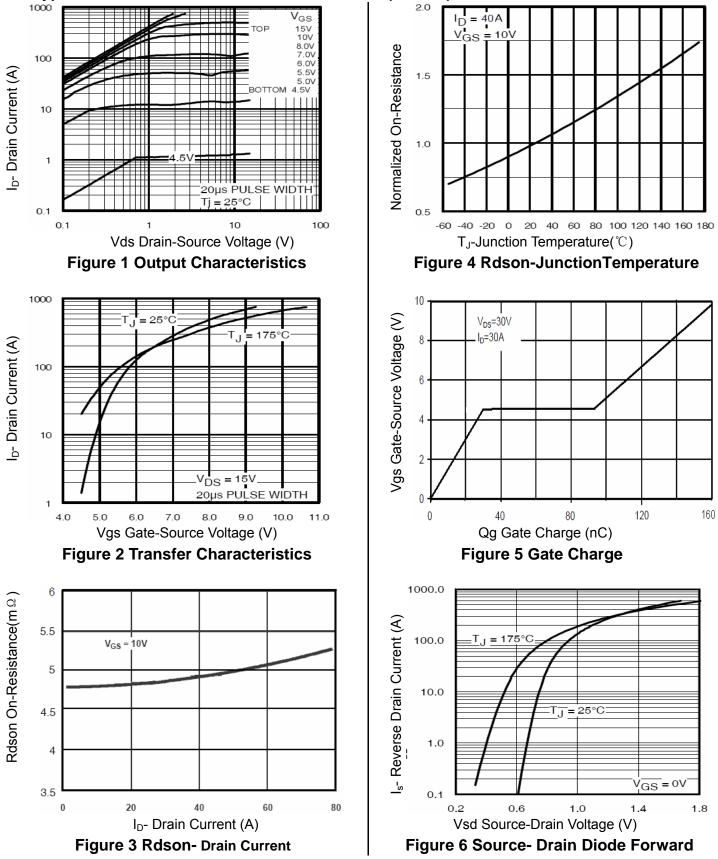


3) Switch Time Test Circuit





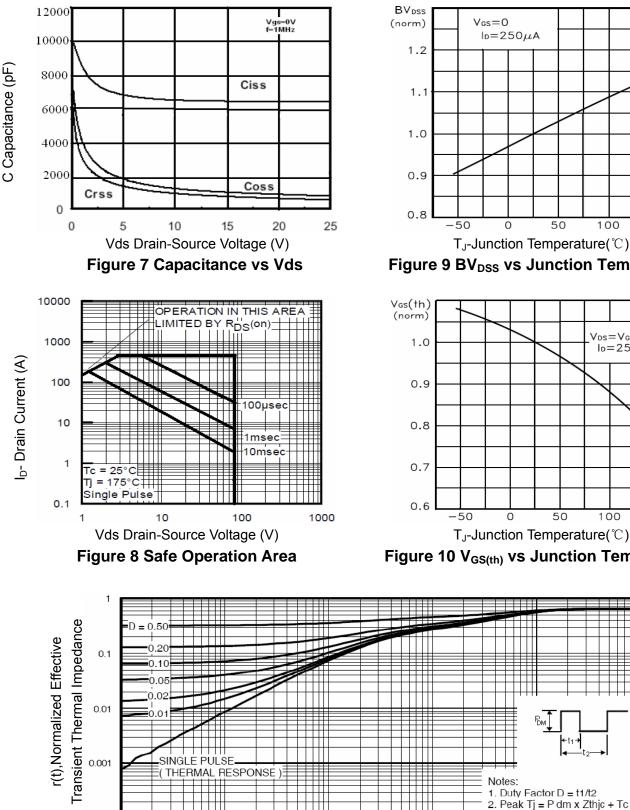














50

100

TJ(°C)

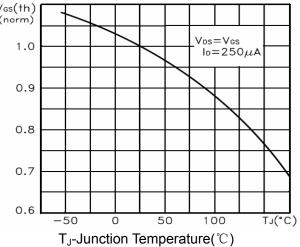
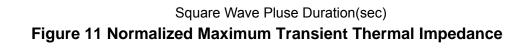


Figure 10 V_{GS(th)} vs Junction Temperature

0.01



0.001

0.0001

1E-006

1E-005

0.0001

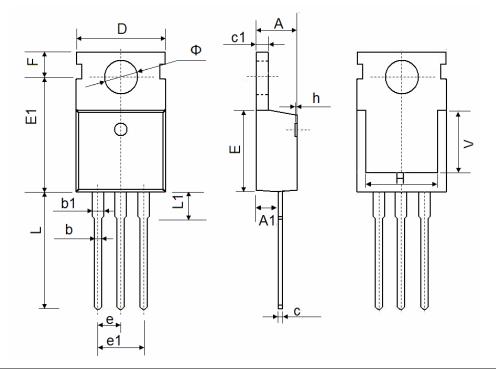
0.1



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NCE80H12

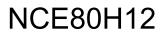
TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	







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